

ADVANCED DIRECT IMAGING by ALTIX

ADIX SA



















4 LEDs wavelengths per Photo Head

Higher Precision
Reliability
Flexibility

Unique Solution for All Direct Imaging Applications

Resolution



Down to 10μm | 0.4 mil

Registration



±8µm | ±0.3mil Image to Panel

High Throughput



≥ 5100 prints / day

High Savings



-80% Cost of ownership





ADIX SA for All Imaging Needs



Enhanced 4 LEDs Photo Heads for Higher **Productivity and Printing Quality**

High Accuracy Registration

Print on All Types of Photoresists & Soldermasks

Lower Cost of Ownership

Fully Intuitive & Friendly HMI

From 1 to 6 ALDS-Power4+™ Photo Heads - Upgradable on site

ADIX SA Specifications

APPLICATIONS PCB • FPCB / Flex • Photo Chemical Milling • IC Substrate • Touch Panel

Inner Layer • Outer Layer • Soldermask (PSR) Conventional **Process Imaging Resist Materials** & DI/LDI Specific Dry Film, Ink & Solder Resists From 10 to

Resist Sensitivity 1.250mJ/cm² and above

Exposure Area From 228 x 254mm up to 610 x 762mm • From 9"x10" up to 24"x30"

Panel Thickness • 10/10μm • 0.4/0.4 mil⁽¹⁾ 0.04 to 6mm 1,6 to 236mils 20/20µm • 0.8/0.8 mil⁽¹⁾ RESOLUTION - L/S 25µm (1mil) **RESOLUTION - DAM** ±0,5µm Edge Roughness ±1,5µm Depth of Focus 100um 200um

ALDS-Power4+™ **Light Engine**

From 1 to 6 Heads - Upgradable on site Imaging Heads Autofocus 4 LEDs wavelengths per Photo Head **Exposure Spectrum**

±0.3mil (Image to Panel Registration) ±0.5mil (Side to Side Registration) ±8µm ALIGNMENT ±12um

- for Outer Layers (Alignment on 4 Holes) 2 Cameras

- for Soldermask Registration (Alignment on 4 Copper Targets) 3 Cameras for Inner Layers (Alignment on 3 Fiducials) **CCD Cameras**

Method Real Time Scaling & Partitioning with all kinds of fiducials

THROUGHPUT

14s with 30mJ/cm² resist for 457 x 610mm (18"x 24") image size and with 6 Heads (2) ALDS-Power4™ Data preprocessing in hidden time + High UV Power with 4 LEDs per Photo Head

3 Phases

ALTIX Direct Imaging Suite™ with 22" touch screen SOFTWARE **Data Input** Extended Gerber, ODB++ (option) - Others upon request

Languages English, Simplified & Traditional Chinese, Korean, German, French... HIGH YIELD

Air Cleanliness

Power Supply

Stainless Steel (Frames & Covers) **GENERAL UTILITIES** 220/400/480V

Hepa Filter Class 100

Power Consumption

Air Supply 6 bars |1.5m3/min

Water Supply Water pressure 3~5 bars

Dimensions 2,870mm (L) x 1,750mm (W) x 1,870mm (H) • 113" (L) x 69" (W) x 74" (H)

Unique Features



Unique Panel Holding

Fully automated bar clamping system & vacuum table for holding all panels thicknesses and counteract warp &



Highest Image Quality

±8mm high dynamic autofocus and up to ±200µm depth of focus to overcome uneven topography surfaces



Higher Resolution: 10µm L/S(*) Use multi-wavelengths UV-LED for best resolution and higher polymerization efficiency on all

or solder resists



Highest Imaging Quality with ALDS™ Imaging on double or triple dry film laminated layers

Excellent and sharp edges



Higher Registration: ±8µm

Real time scaling and partitioning to reach the highest local registration for very demanding application



Side to Side Registration:±12µm

Highest side-to-side registration on all area of the panels thanks to its unique way of registration



Higher Productivity

4 UV LED wavelengths for the highest efficiency printing



Smart Automation

Fully automated systems and customized solutions for high mix, small, medium & mass production

Imaging with us!



Manufacturing, Sales & Service:

Altix France - HO Email: central@altix.fr Asia:

Altix China

Flow rate: 23l/min @ 12°C or 33l/min @ 14°C

Shanghai, Kunshan, Zhuhai Offices

Email: central@altix.cn

North America:

Altix NA, Inc. United States, Canada, Mexico Email: central@altix.us



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